

#### Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

**DFN-1006** 

E3331

### General Description

The PAE3331EU is designed with latest Punch -Through process TVS technology to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, USB 3.0 super speed, VGA, DVI, HDMI, eSATA and other high speed line applications.

It has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD(electrostatic discharge), and EFT (electrical fast transients).

#### Feature

- ●Peak Power Dissipation 60 W (8 x 20 us Waveform)
- •Stand-off Voltage: 3.3 V
- ●Low capacitance (<0.3pF) for high-speed interfaces
- ●No insertion loss to10.0GHz
- •Replacement for MLV (0402)
- Protects I/O Port
- ●Low Clamping Voltage
- •Low Leakage
- •Low Capacitance
- •Meets MSL 1 Requirements
- ●ROHS compliant
- ●Solid-state Punch-Through TVS Process technology

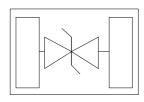
#### > <u>Application</u>

- ●High Speed Line :USB1.0/2.0/3.0/3.1, VGA, DVI, SDI,
- High Definition Multi-Media Interface (HDMI1.3/1.4/2.0)
- Serial and Parallel Ports
- •Notebooks, Desktops, Servers
- Projection TV
- •Cellular handsets and accessories
- •Portable instrumentation
- Peripherals

### Protection solution to meet

●IEC61000-4-2 (ESD) ±20kV (air), ±20kV (contact)







Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

### Maximum Ratings (TA=25°C Unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (tp=8/20µs waveform)	Рррр	60	Watts	
ESD Rating per IEC61000-4-2: Contact		20	KV	
Air		20		
Lead Soldering Temperature	TL	260 (10 sec.)	°C	
Operating Temperature Range	TJ	-55 ~ 150	°C	
Storage Temperature Range	Tstg	-55 ~ 150	°C	
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	°C	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

\*Other voltages may be available upon request.

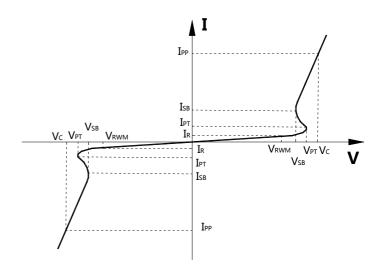
1. Non-repetitive current pulse, per Figure 1.

### Electrical Characteristics (TA=25°C Unless otherwise specified)

VRWM		V <sub>PT</sub> @ 1 mA		Rdyn	Vc	Capacitance		
Device	V RWM	IR @ VRWM	(Va	olts)	Ω	@ 1 A	(a) $V_R = 0 V$ ,	1 MHz (pF)
	(V)	(uA)	Min	Max	Тур.	(V)	Тур	Max
PAE3331EU	3.3	1	4.6	10	0.83	10.0	0.15	0.3

Junction capacitance is measured in VR=0V,F=1MHz

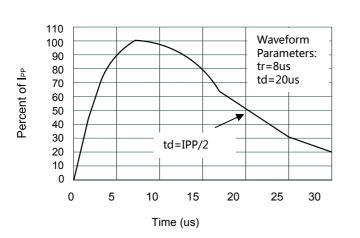
Symbol	Parameter	
Vrwm	Working Peak Reverse Voltage	
Vpt	Punch-Through Voltage@ IPT	
Vsb	Snap-Back Voltage@ ISB	
Vc	Clamping Voltage @ IPP	
IT	Test Current	
Irm	Leakage current at VRWM	
Ipp	Peak pulse current	
Co	Off-state Capacitance	
CJ	Junction Capacitance	



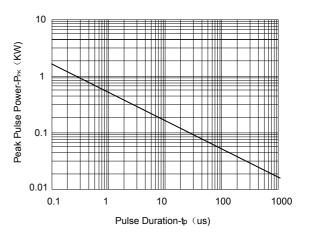


PAE3331EU Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

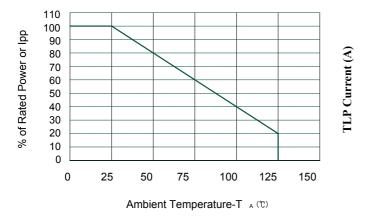
# Typical Characteristics



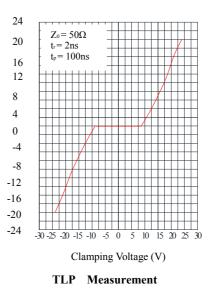
**Pulse Waveform** 



Non-Repetitive Peak Pulse Power vs. Pulse Time



**Power Derating Curve** 



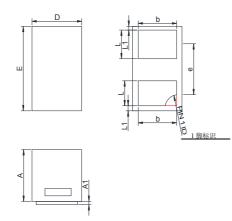


<u>PAE3331EU</u>

Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

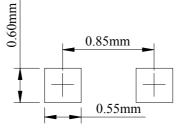
## Package Information (DFN-1006)

Case Material: Molded Plastic. UL Flammability



DIM	Millimeters		
	Min	Max	
А	0.30	0.50	
A1	0.00	0.05	
D	0.55	0.65	
Е	0.95	1.05	
b	0.25	0.60	
e	0.65TYP		
L	0.15	0.35	
L1	0.05REF		

#### **Recommended Pad outline**



## Ordering Information

Part Number	Description	Quantity
PAE3331EU	DFN-1006 Reel	10000 pcs



Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

# DISCLAIMER

- The information in this document and any product described herein are subject to change without notice and should not be construed as a commitment by Paceleader, Paceleader reserve the right to make changes to the information in this document.
- Though Paceleader make effort to improve product quality and reliability, Product can malfunction and fail due to their inherent electrical sensitivity and vulnerability to physical stress, it is the responsibility of the customer, when utilizing Paceleader products, to comply with the standards of safety in making a safe design for entire system and to avoid situation in which a malfunction or failure., In developing a new designs, customer should ensure that the device which shown in this documents are used within specified operating ranges.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by Paceleader for any infringements of patents or other rights of the third parties which may result from its use.